

FGW40N120HD

Discrete IGBT (High-Speed V series) 1200V / 40A

■ Features

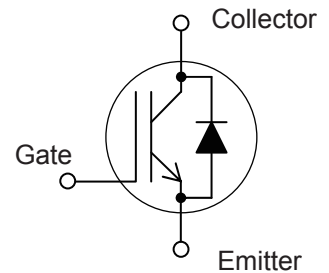
- Low power loss
- Low switching surge and noise
- High reliability, high ruggedness (RBSOA, SCSOA etc.)

■ Applications

- Uninterruptible power supply
- Power conditioner
- Power factor correction circuit



■ Equivalent circuit



■ Maximum Ratings and Characteristics

● Absolute Maximum Ratings (at T_c=25°C unless otherwise speales Vt T s

Gate-Emitter Voltage	V _{GES}	±20	V	
DC Collector Current	I _{C@25}	70	A	T _c =25°C, T _j =150°C
Pulsed Collector Current	I _{C@100}	40	A	T _c =100°C, T _j =150°C
Turn-Off Safe Operating Area	I _{CP}	120	A	Note *1
Diode Forward Current	I _{F@25}	52	A	V _{CE} 1200V, T _j 175°C
Diode Pulsed Current	I _{F@100}	30	A	
Short Circuit Withstand Time	t _{SC}	5	μs	Note *1
IGBT Max. Power Dissipation	P _{D,IGBT}	340	W	V _{CC} 600V, V _{GE} =12V
FWD Max. Power Dissipation	P _{D,FWD}	190	W	T _j 150°C
Operating Junction Temperature	T _j	-40 ~ +175	°C	T _c =25°C
Storage Temperature	T _{stg}	-55 ~ +175	°C	T _c =25°C

Note *1 : Pulse width limited by T_{jmax}.

● Electrical characteristics (at T_j= 25°C unless otherwise specified)

Items	Symbols	Conditions	Characteristics			Units
			min.	typ.	max.	
Collector-Emitter Breakdown Voltage	V _{BRICES}	I _c = 50μA, V _{GE} = 0V	1200	-	-	V
Zero Gate Voltage Collector Current	I _{CES}	V _{CE} = 1200V, V _{GE} = 0V	-	-	250	μA
Gate-Emitter Leakage Current	I _{GES}	V _{CE} = 0V, V _{GE} = ±20V	-	-	200	nA
Gate-Emitter Threshold Voltage	V _{GE(th)}	V _{CE} = ±20V, I _c = 40mA	4.0	5.0	6.0	V
Collector-Emitter Saturation Voltage	V _{CE(sat)}	V _{GE} = +15V, I _c = 40A	-	1.8	2.34	V
Input Capacitance	C _{ies}	V _{CE} =25V	-	3000	-	pF
Output Capacitance	C _{oes}	V _{CE} =0V	-	130	-	pF
Reverse Transfer Capacitance	C _{res}	f = 1MHz	-	100	-	pF
Gate Charge	Q _G	V _{CC} = 600V I _c = 40A V _{GE} = 15V	-	300	-	nC
Turn-On Delay Time	t _{d(on)}	I _J = 25°C	-	35	-	ns
Rise Time	t _r	V _{CC} = 600V	-	60	-	ns
Turn-Off Delay Time	t _{d(off)}	I _c = 40A	-	315	-	ns
Fall Time	t _f	V _{GE} = 15V	-	40	-	ns
Turn-On Energy	E _{on}	R _G = 10 L = 500μH	-	2.8	-	mJ
Turn-Off Energy	E _{off}	Energy loss include "tail" and FWD reverse recovery	-	1.8	-	mJ
Turn-On Delay Time	t _{d(on)}	I _J = 175°C	-	35	-	ns
Rise Time	t _r	V _{CC} = 600V	-	60	-	ns
Turn-Off Delay Time	t _{d(off)}	I _c = 40A	-	350	-	ns
Fall Time	t _f	V _{GE} = 15V	-	75	-	ns
Turn-On Energy	E _{on}	R _G = 10 L = 500μH	-	4.8	-	mJ
Turn-Off Energy	E _{off}	Energy loss include "tail" and FWD reverse recovery.	-	3.0	-	mJ

● FWD Characteristics

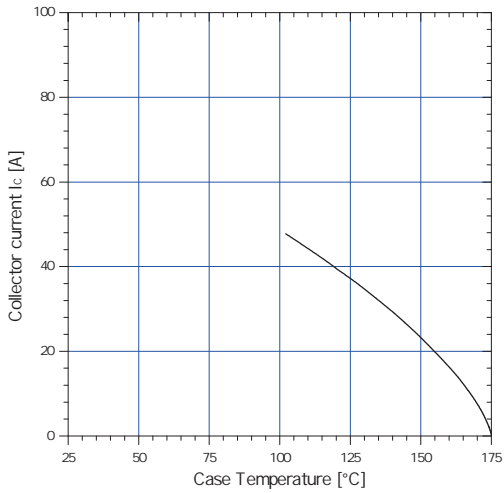
Description	Symbol	Conditions	Characteristics			Unit	
			min.	typ.	max.		
Forward Voltage Drop	V_F	$I_F=30A$	$T_j=25^{\circ}C$	-	2.2	2.8	V
			$T_j=175^{\circ}C$	-	1.8	-	V
Diode Reverse Recovery Time	t_{rr1}	$V_{CC}=30V, I_F = 3.0A$ $-di/dt=200A/\mu s$	-	49	-	ns	
Diode Reverse Recovery Time	t_{rr2}	$V_{CC}=600V$ $I_F=30A$	-	0.44	-	μs	
Diode Reverse Recovery Charge	Q_{rr}	$-di_F/dt=200A/\mu s$ $T_j=25^{\circ}C$	-	1.35	-	μC	
Diode Reverse Recovery Time	t_{rr2}	$V_{CC}=600V$ $I_F=30A$	-	0.70	-	μs	
Diode Reverse Recovery Charge	Q_{rr}	$-di_F/dt=200A/\mu s$ $T_j=175^{\circ}C$	-	6.00	-	μC	

● Thermal resistance characteristics

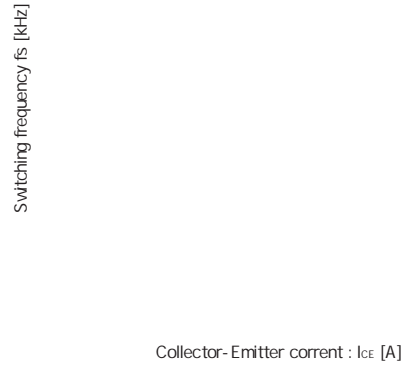
Items	Symbols	Conditions	Characteristics			Units
			min.	typ.	max.	
Thermal Resistance, Junction-Ambient	$R_{th(j-a)}$	-	-	-	50	$^{\circ}C/W$
Thermal Resistance, IGBT Junction to Case	$R_{th(j-c)}_{IGBT}$	-	-	-	0.439	
Thermal Resistance, FWD Junction to Case	$R_{th(j-c)}_{FWD}$	-	-	-	0.781	

■ Characteristics (Representative)

Graph.1
DC Collector Current vs T_c
 $V_{GE} \geq +15V, T_c \leq 175^\circ C$



Graph.2
Collector Current vs. switching frequency
 $V_{GE} = +15V, T_c \leq 175^\circ C, V_{CE} = 600V, D = 0.5,$
 $R_G = 10\Omega, T_c = 100^\circ C$



Graph.3
Typical Output Characteristics ($V_{CE}-I_c$)
 $T_j = 25^\circ C$



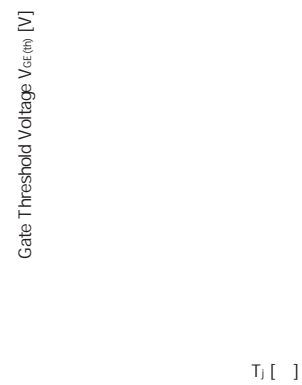
Graph.4
Typical Output Characteristics ($V_{CE}-I_c$)
 $T_j = 175^\circ C$



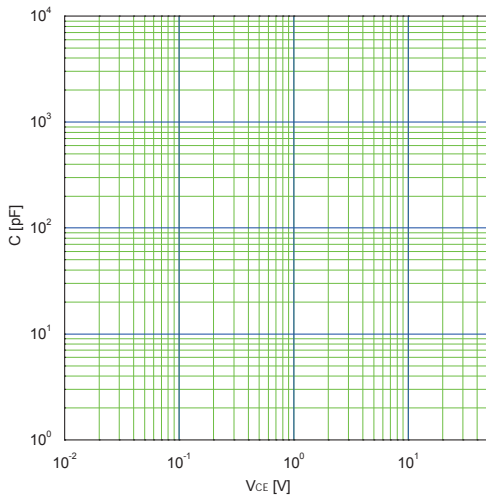
Graph.5
Typical Transfer Characteristics
 $V_{GE} = +15V$



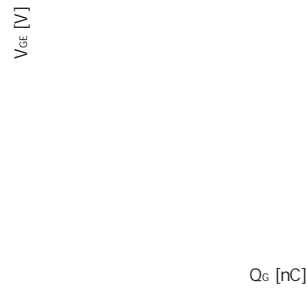
Graph.6
Gate Threshold Voltage vs. T_j
 $I_c = 40mA, V_{CE} = 20V$



Graph.7
Typical Capacitance
 $V_{GE}=0V, f=1MHz, T_j=25^{\circ}C$



Graph.8
Typical Gate Charge
 $V_{cc}=600V, I_c=40A, T_j=25^{\circ}C$



Graph.9
Typical switching time vs. Ic
 $T_j=175^{\circ}C, V_{cc}=600V, L=500\mu H$
 $V_{GE}=15V, R_G=10\Omega$

Switching Times [nsec]

Graph.10
Typical switching time vs. RG
 $T_j=175^{\circ}C, V_{cc}=600V, I_c=40A, L=500\mu H$
 $V_{GE}=15V$

Switching Times [nsec]

Collector Current Ic [A]

Graph.11
Typical switching losses vs. Ic
 $T_j=175^{\circ}C, V_{cc}=600V, L=500\mu H$
 $V_{GE}=15V, R_G=10\Omega$

Switching Energy Losses [mJ]

Gate Resistor RG [Ω]

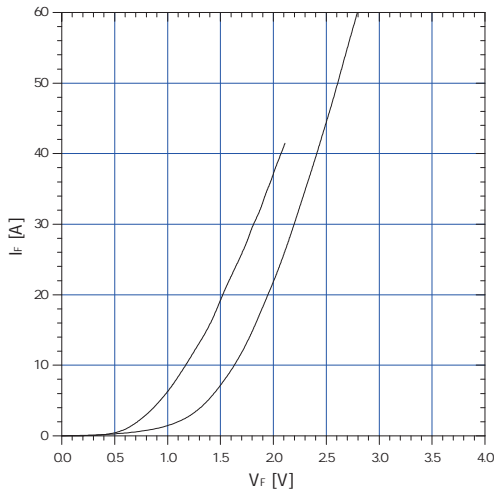
Graph.12
Typical switching losses vs. RG
 $T_j=175^{\circ}C, V_{cc}=600V, I_c=40A, L=500\mu H$
 $V_{GE}=15V$

Switching Energy Losses [mJ]

Collector Current Ic [A]

Gate Resistor RG [Ω]

Graph.13
FWD Forward voltage drop (V_F-I_F)



Graph.15
Typical reverse recovery loss vs. I_F
 $T_J=175^\circ\text{C}$, $V_{CC}=600\text{V}$, $L=500\mu\text{H}$
 $V_{GE}=15\text{V}$, $R_G=10\Omega$

Reverse recovery loss [μW]

I_F [A]

Graph.14
Typical reverse recovery characteristics vs. I_F
 $T_J=175^\circ\text{C}$, $V_{CC}=600\text{V}$, $L=500\mu\text{H}$
 $V_{GE}=15\text{V}$, $R_G=10\Omega$

Reverse recovery Time [nsec]

Reverse Recovery Charge [μC]

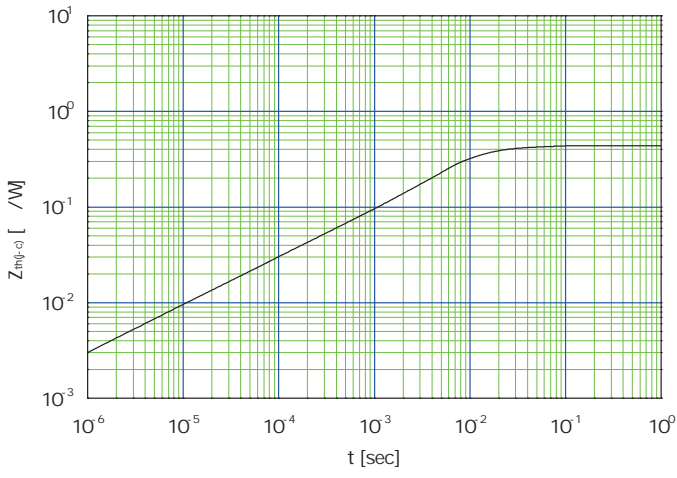
I_F [A]

Graph.16
Reverse biased Safe Operating Area
 $T_J \leq 175^\circ\text{C}$, $V_{GE}=+15\text{V}/0\text{V}$, $R_G=10\Omega$

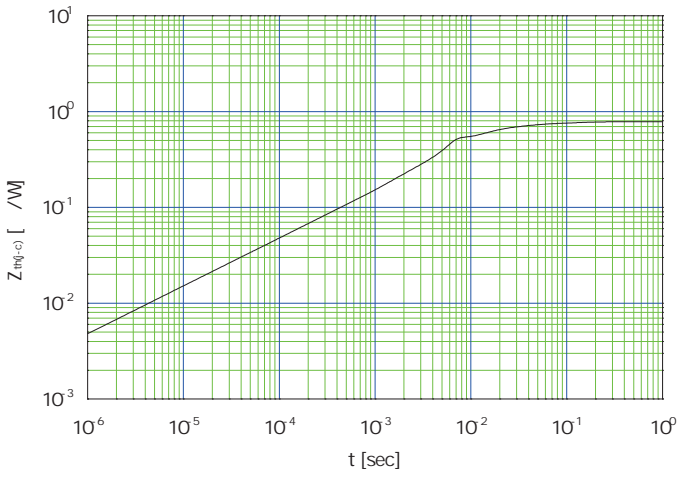
Collector current I_C [A]

Collector-Emitter voltage : V_{CE} [V]

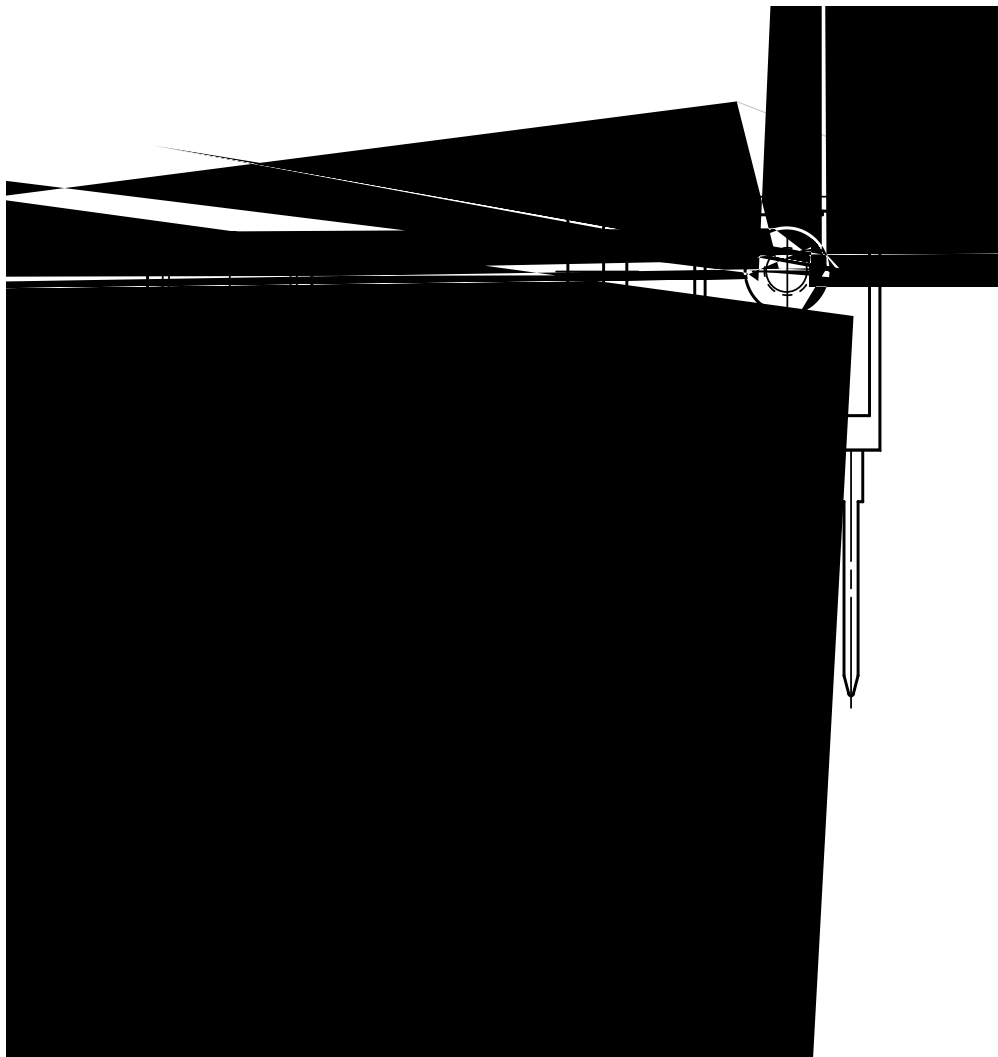
Graph.17
Transient thermal resistance of IGBT



Graph.18
Transient thermal resistance of FWD



■ Outline Drawings, mm



WARNING

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